

February 2015

FPF2498 Adjustable OVP with 28 V Input OVT Load Switch

Features

Function	Advanced Load Switch		
Input	3.5 – 12 V		
Features	28 V Absolute Ratings on VIN 1.7 A Maximum Continuous Current Capability 80 mΩ R _{ON} Typical Over-Voltage Protection (OVP) Over-Current Protection (OCP) Thermal Shutdown Under-Voltage Lockout (UVLO) Reverse Current Blocking (RCB)		
ESD	15 kV IEC 61000-4-2 Air Gap		
Operating Temperature Range	-40 to +85°C		
Package	6-Ball WLCSP (1.05 x 1.3 x 0.625 mm, 0.4 mm Pitch)		
Ordering Information	FPF2498BUCX		
Top Mark	ТК		

Description

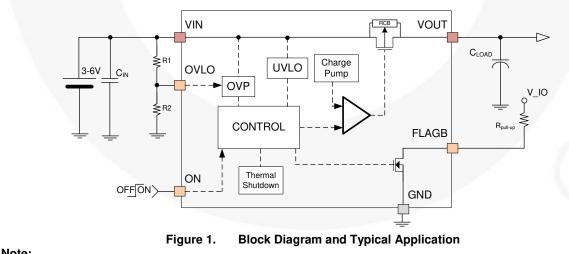
The FPF2498 advanced load-management switch targets applications requiring a highly integrated solution. It disconnects loads powered from the DC power rail (<12 V) with stringent off-state current targets and high load capacitances (<100 µF). The FPF2498 consists of a slew-rate controlled low-impedance MOSFET switch. FPF2498 has over-voltage protection and over-temperature protection.

Applications

- Cellular Phones, Smart Phones
- Tablets

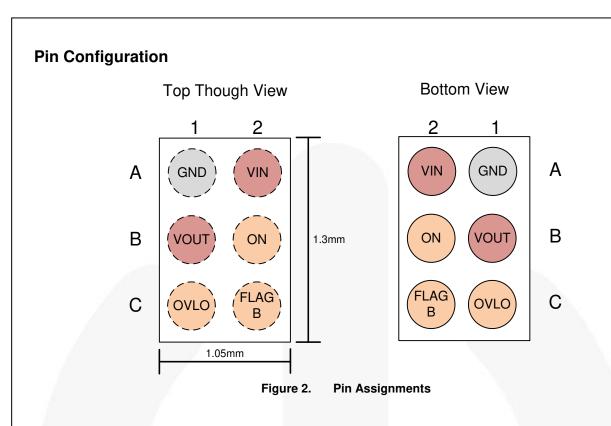
Related Resources

FPF2498 Evaluation Board



Note:

1. Recommend C_{LOAD} value be larger than 2.2 µf.



Pin Map

Name	Pin #	Туре	Default State		Description		
VIN	A2	Input	N/A	Input voltage path			
VOUT	B1	Output	N/A	Output voltage path	Output voltage path		
ON	B2	linerit		On / Off control of device	V _{IH} =HIGH	Enabled	
ON	DZ	Input	LOW		V _{IL} =LOW	Disabled	
OVLO	C1	Input		OVP Adjustment set by R1 and R2 and is compared to 1.2 V – V _{IN} × R2 / (R1+R2) >1.2 V			
FLAGB	C2	Open- Drain Output	High-Z	Indicates a OVP / OCP / LOW / GND OVF		Active – Indicates: OVP (over 6.5 V at 3 – 6 V) OCP (over 2 A) OTP (over 150°C)	
		•			HIGH / V_IO	Normal Operation	
GND	A1	GND	GND	Device ground			

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Pa	rameters	Min.	Max.	Unit
	Voltage on VIN to GND, VIN to VO	JT, OVLO Pins	-0.3	28.0	
V _{PIN}	Voltage on ON, FLAGB Pins		-0.3	6.0	V
	Voltage on VOUT to GND Pins		-0.3	20.0	
I _{SW}	Maximum Switch Current			1.75	А
t _{PD}	Total Power Dissipation at $T_A=25^{\circ}C$			1	W
TJ	Operating Junction Temperature		-40	+150	°C
T _{STG}	Storage Junction Temperature			+150	°C
Θja	Thermal Resistance, Junction-to-Ambient (1-inch Square Pad of 2 oz. Copper)			95 ⁽²⁾ 110 ⁽³⁾	°C/W
	Electrostatic Discharge Capability Human Body Model, ANSI / ESDA / JEDEC JS-00	Human Body Model, ANSI / ESDA / JEDEC JS-001-2012	3		
ESD		Charged Device Model, JESD22-C101	2		kV
	IEC61000.4.2 System Lovel	Air Discharge (VIN, VON, VOUT to GND)	15	5	
	IEC61000-4-2 System Level	Contact Discharge (V_{IN} , V_{ON} , V_{OUT} to GND)	8		

Notes:

2. Measured using 2S2P JEDEC std. PCB.

3. Measured using 2S2P JEDEC PCB cold plate method.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameters		Max.	Unit
V _{IN}	Supply Voltage		12.0	V
Isw	I _{SW} Maximum Continues Switch Current ⁽⁴⁾		1.7	А
T _A	T _A Ambient Operating Temperature		85	°C

Note:

4. Maximum Junction Temperature = 85°C

Unless otherwise noted; V_{IN} =3.5 to 5.5 V, T_A =-40 to +85°C; typical values are at V_{IN} =5 V and T_A =25°C.

Electrical Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Basic Opera	ation		•			
I _{SD(OFF)}	Shutdown Current	V _{IN} =5.5 V, V _{OUT} =0 V, V _{ON} =GND		0.4	3.0	μA
ΙQ	Quiescent Current	V _{IN} =5.5 V, V _{OUT} =Floating, I _{OUT} =0 mA		90	125	μA
		V _{IN} =3.7 V, I _{OUT} =200 mA		90		
Р		V _{IN} =5.0 V, I _{OUT} =200 mA		80	95 ⁽⁵⁾	mΩ
R _{ON}	On Resistance	V _{IN} =9 V, I _{OUT} =200 mA				
		V _{IN} =12 V, I _{OUT} =200 mA				
VIH	ON Input Logic HIGH Voltage	V _{IN} =3.5 V to 5.5 V	1.15			V
V _{IL}	ON Input Logic LOW Voltage	V _{IN} =3.5 V to 5.5 V			0.65	V
Vol_flag	FLAGB Output Logic LOW Voltage	V _{IN} =5 V, I _{SINK} =1 mA		0.10	0.20	V
I _{FLAGB_LK}	FLAGB Output HIGH Leakage Current	V _{IN} =5 V, Switch On			0.5	μA
RPD	Pull-Down Resistance on ON Pin	V _{IN} =5 V, OVLO=GND		3		M
Over-Voltag	ge Protection					
		V _{IN} Rising Threshold OVLO=GND	6.2	6.5	6.8	
V _{OV_TRIP}	Default Input OVP Lockout	VIN Falling Threshold OVLO=GND		6.2	8	V
Vovlo_sel	Voltage threshold for OVLO selection	V _{IN} =3.5 V to 5.5 V, OVLO=GND		0.3		V
V _{OVP_HYS}	Input OVP Hysteresis	V _{IN} Falling Threshold OVLO=External Setting		0.3		v
V _{OVLO_TH}	OVLO Set Threshold	VIN=3.5 to VOVLO		1.20		V
t _{OVP}	Response Time	I_{OUT} =0.5 A, C _L =0 µF, T _A =25°C, V _{IN} =6 V to 7 V		0.5	1	μ
		V _{IN} Rising		3.2		
V _{UVLO}	Under-Voltage Lockout	V _{IN} Falling		3.0		V
VUVLO_HYS	UVLO Hysteresis			200		m
I _{RCB}	RCB Current	V _{ON} =0 V, V _{OUT} =5.5 V, V _{IN} =0 V		2	5	μ
		Shutdown Threshold		150		
TSD	Thermal Shutdown	Return from Shutdown		130		°(
		Hysteresis		20		
Over-Curre	nt Protection					
I _{OCP}	Over-Current Protection Trip Point	I _{SW} > I _{OCP}		2		A
Dynamic Cl	haracteristics	I	1		1	
t _{DON}	Turn-On Delay ⁽⁷⁾			4.3		m
t _R	V _{OUT} Rise Time ⁽⁷⁾			3.0		m
t _{on}	Turn-On Time ⁽⁸⁾	V_{IN} =5 V, R _L =100 Ω, C _L =10 μF, T _A =25°C		7.3		m
t _{DOFF}	Turn-Off Delay ^(6,7)			600		μ
t _F	V _{OUT} Fall Time ^(6,7)			2.0		m
t _{OFF}	Turn-Off Time ^(6,9)			2.5		m
t _{READY}	Time for Device Ready for Large Load	C _L =10 μF		5		m

© 2013 Fairchild Semiconductor Corporation FPF2498 • Rev. 1.11

FPF2498 — Adjustable OVP with 28 V Input OVT Load Switch

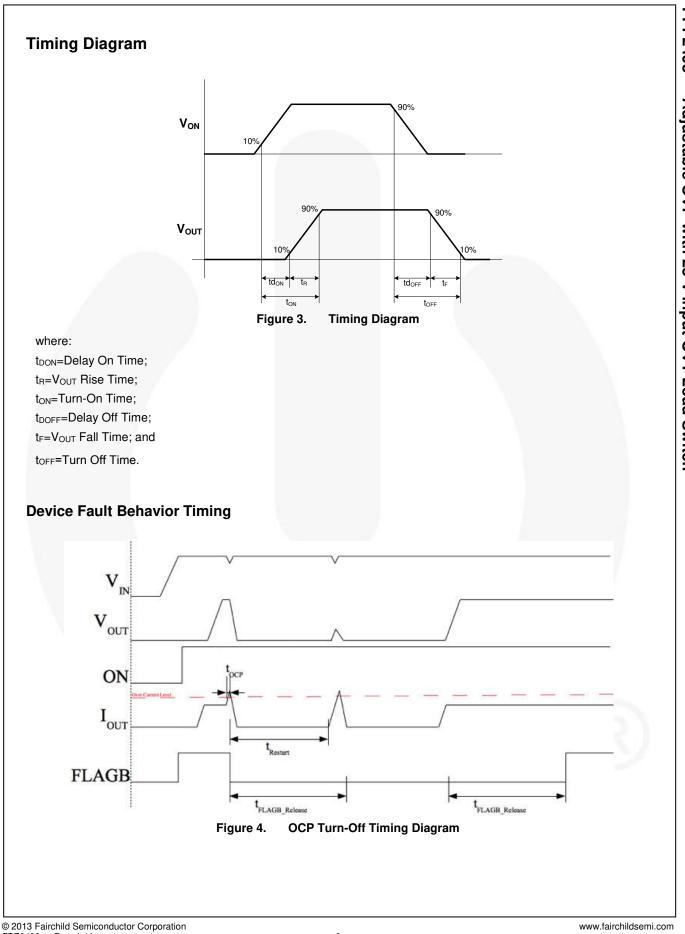
Electrical Characteristics

Unless otherwise noted; V_{IN} =3.5 to 5.5 V, T_A =-40 to +85°C; typical values are at V_{IN} =5 V and T_A =25°C.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
t _{restart}	Over-Current Blanking Time ⁽⁶⁾	V _{IN} =5 V I _{OUT} ≥ 1.7 A		64		ms
tocp	Over-Current Response Time ⁽⁶⁾	Moderate Over-Current Condition; I _{OUT} ≥ I _{LIM} V _{OUT} ≤ V _{IN}		4		μs
thocp	Hard Over-Current Response Time	Moderate Over-Current Condition; $I_{OUT} \ge I_{LIM} V_{OUT} \le 0 V$		3		μs
t _{FLAGB_Release}	Over-Current/Voltage/Temp. Flag Release Time ⁽⁶⁾	Time for Flag to Release when Fault Condition Removed		100		ms

Notes:

- 5. T_A=25°C.
- 6. This parameter is guaranteed by design and characterization; not production tested.
- 7. $t_{DON}/t_{DOFF}/t_{R}/t_{F}$ are defined in figure below.
- 8. $t_{ON}=t_R + t_{DON}$.
- 9. $t_{OFF}=t_F + t_{DOFF}$.
- 10. After t_{READY} , the device is ready for maximum DC current load condition.



Operation and Application Description

Input Capacitor

To limit the voltage drop on the input supply caused by transient inrush current when the switch turns on into discharge load capacitor; a capacitor must be placed between the VIN and GND pins. A high-value C_{IN} capacitor can be used to reduce the voltage drop in high-current applications.

Output Capacitor

An output capacitor should be placed between the VOUT and GND pins. This capacitor prevents parasitic board inductance from forcing V_{OUT} below ground when the switch is on. This capacitor also prevents reverse inrush current from creating a voltage spike that could damage the device in the case of a V_{OUT} short.

Fault Reporting

Upon the detection of an over-voltage, over-current, or over-temperature condition, the FLAGB signals the fault by activating LOW.

Under-Voltage Lockout (UVLO)

The under-voltage lockout turns the switch off if the input voltage drops below the lockout threshold. With the ON pin active, the input voltage rising above the UVLO threshold releases the lockout and enables the switch.

Over-Voltage Lockout (OVLO)

The OVLO pin sets the over-voltage lockout trip point with a resistor-divider network. OVLO adjustment is set by R1 and R2 and is compared to 1.2 V – V_{IN} × R2 / (R1+R2) >1.2 V. when V_{IN} > V_{OVLO} the switch turns off to ensure protection to devices connected to VOUT. A 1 M Ω or larger resistor is recommended on R1 to reduce standby power consumption. To use the default values of 5.8 V for V_{OVLO}, connect the OVLO pin directly to GND.

Package Specific Dimensions

Reverse-Current Blocking (RCB)

The reverse-current blocking feature protects the input source against current flow from output to input. When the load switch is OFF, no current flows from the output to input.

Thermal Shutdown (TSD)

Thermal shutdown protects the die from internally or externally generated excessive temperature. During an over-temperature condition, the switch is turned off. The switch automatically turns on again if the temperature of the die drops below the threshold temperature.

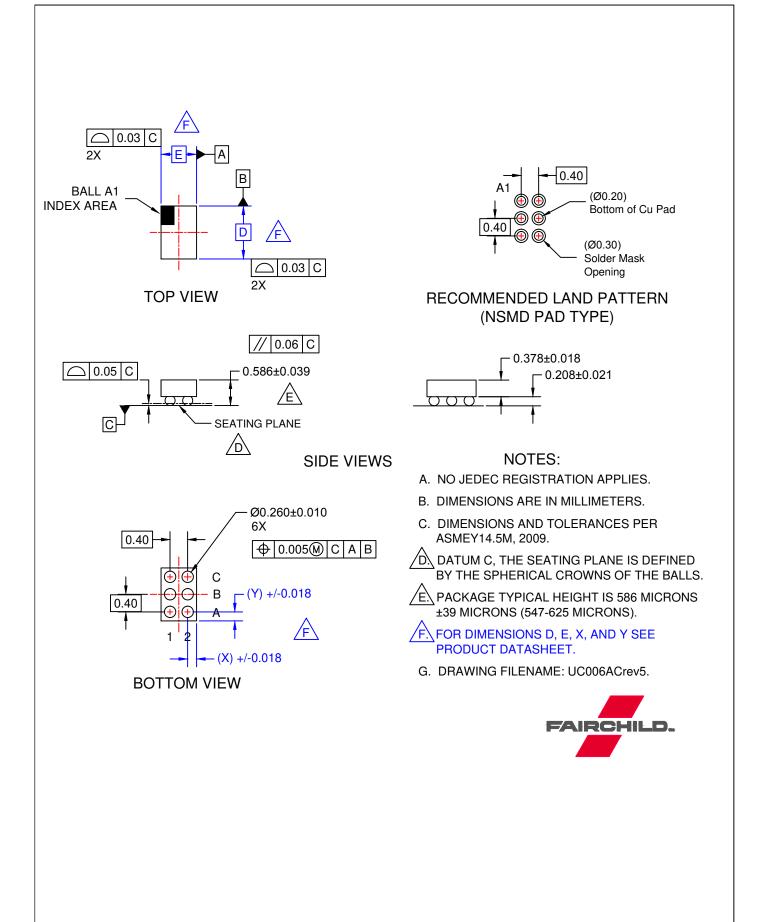
Current Limit

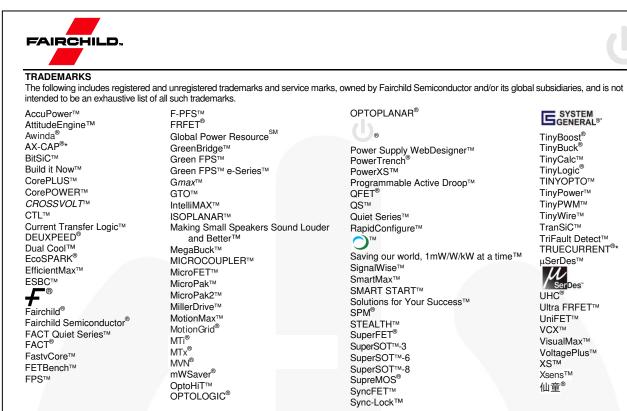
The current limit ensures that the current flow though the switch doesn't exceed a maximum value, which can damage the device. If the current flow though the switch exceeds the trip point, the switch turns off and enters the blanking time. After the blanking time, the switch is re-enabled and checks if the fault still exists.

Board Layout

For best performance, all traces should be as short as possible. The input and output capacitors should be placed close to the device to minimize the effect that parasitic trace inductance may have on normal and short-circuit operation. Using wide traces for VIN, VOUT, GND minimizes parasitic electrical effects along with minimizing the case-to-ambient thermal impedance.

D	E	X	Y	
1.300±0.030	1.050±0.030	0.325	0.250	





* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. TO OBTAIN THE LATEST, MOST UP-TO-DATE DATASHEET AND PRODUCT INFORMATION, VISIT OUR WEBSITE AT <u>HTTP://WWW.FAIRCHILDSEMI.COM</u>, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

AUTHORIZED USE

Unless otherwise specified in this data sheet, this product is a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability. This product may not be used in the following applications, unless specifically approved in writing by a Fairchild officer: (1) automotive or other transportation, (2) military/aerospace, (3) any safety critical application – including life critical medical equipment – where the failure of the Fairchild product reasonably would be expected to result in personal injury, death or property damage. Customer's use of this product is automative of this Authorized Use policy. In the event of an unauthorized use of Fairchild's product, Fairchild accepts no liability in the event of product failure. In other respects, this product shall be subject to Fairchild's Worldwide Terms and Conditions of Sale, unless a separate agreement has been signed by both Parties.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Terms of Use

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms		
Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 177